

Product Document



Datasheet

DS000685

TARA2000-850-UW-AUT

Automotive High-Power Flood Illuminator

v4-00 • 2023-Mar-28

Abstract

The TARA2000-850-UW-AUT is a small form factor surface mount infrared laser illuminator enabling 2D and 3D use cases on a variety of platforms for in-cabin sensing applications.

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1 General Description

1.1 Key Benefits & Features

The TARA2000-850-UW-AUT module is specifically designed for monochromatic, infrared, high-power, uniform illumination.

The compact modules are assembled with ams OSRAM state-of-the-art component manufacturing processes and are reflow solderable. Those modules, using laser illumination, allow improved efficiency, reduced footprint, and overall improved system performance.

Figure 1:
Added Value Overview

Benefits	Features
Small package size	4.1 mm x 4.1 mm x 1.38 mm ±0.100 mm
Power efficient	High power conversion efficiency
Easy component mounting	Standard lead-free solder reflow compatible
Uniform power distribution	100% tested for uniformity in the far field
Automotive qualified	AEC-Q102 standard
Safety compliance	ISO2626 compliant
Safety ASIL level	ASIL A
Full traceability	Unit level track with 2D barcode

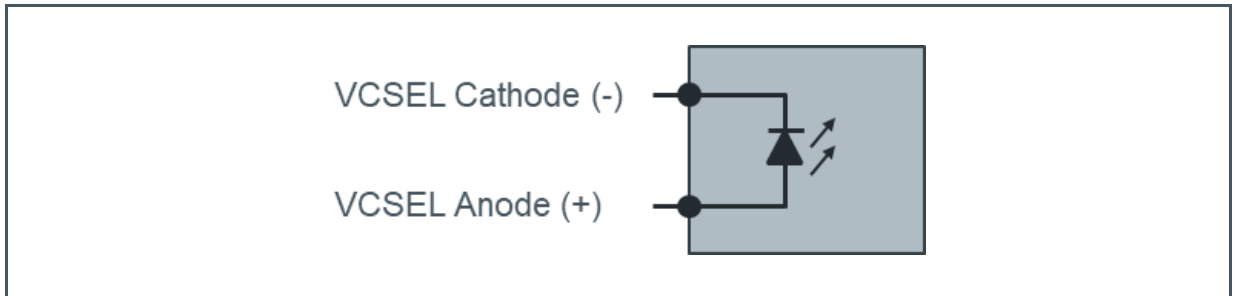
1.2 Applications

- Illumination for 3D Time-of-Flight and 2D Near-Infrared Cameras for in-cabin sensing
- Gesture Recognition
- In-cabin Monitoring
- Occupants Detection

1.3 Block Diagram

The functional block of this device is shown below:

Figure 2:
Functional Block of TARA2000-850-UW-AUT



1.4 Other General Characteristics

Some additional features of this device are shown below:

Figure 3:
Additional Characteristics

Parameter	Value
Light Source	VCSEL
Electrical Contacts	Anode/Cathode on backside
Number of Electrical Contacts	1x Cathode ; 1x Anode
Assembly Type	Reflow Compatible

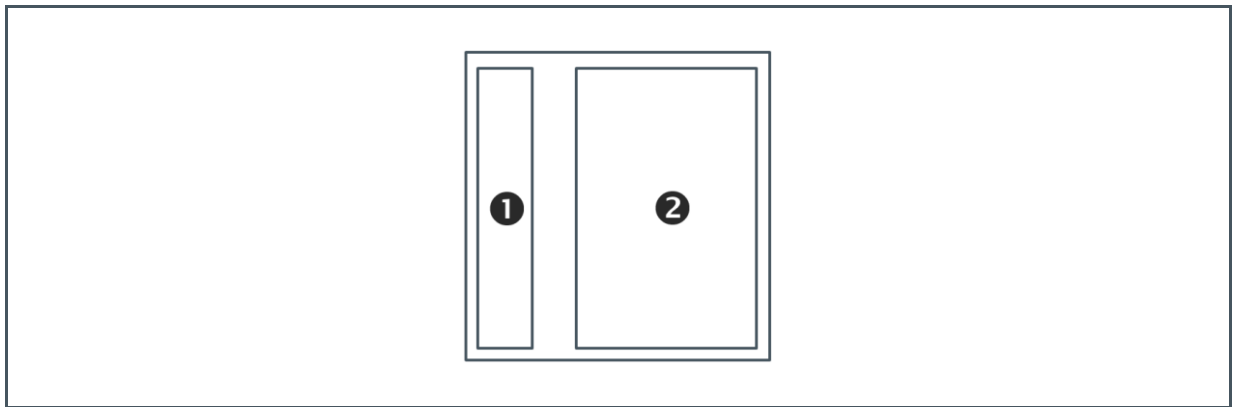
2 Ordering Information

Ordering Code	Description	Delivery Form	Delivery Quantity
ASDA-00	TARA2000-850-UW-AUT	Tape & Reel	4000 pcs/reel

3 Pin Assignment

3.1 Pin Diagram

Figure 4:
Pin Diagram: Module Bottom View



3.2 Pin Description

Figure 5:
Pin Description of TARA2000-850-UW-AUT

Pin Number	Pin Name	Description
1	Anode	VCSEL Power
2	Cathode	VCSEL Power

4 Absolute Maximum Ratings

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under “Operating Conditions” is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Figure 6
Absolute Maximum Ratings of TARA2000-850-UW-AUT

Symbol	Parameter	Min	Max	Unit	Comments
Electrical Parameters					
$I_{F,LD}$	Laser Diode Forward Current		10	A	Duty cycle = 1% Pulse width = 100 μ s @ 25 °C
$V_{R,LD}$	Laser Diode Reverse		5	V	DC mode @ 25 °C
$I_{R,LD}$	Laser Diode Reverse Current		25	nA	DC mode @ 25 °C
Electrostatic Discharge					
ESD_{HBM}	Electrostatic Discharge HBM		± 2	kV	JEDEC JS-001-2017
ESD_{CDM}	Electrostatic Discharge CDM		± 750	V	JEDEC JS-002-2018
Temperature Ranges and Storage Conditions					
T_A	Operating Ambient Temperature	-40	105	°C	
T_{STRG}	Storage Temperature Range	-40	125	°C	
RH_{NC}	Relative Humidity (non-condensing)		85	%	
MSL	Moisture Sensitivity Level		3		Maximum floor life time of 168h JEESD22-A113D

5 Performance Characteristics

All limits are guaranteed. The parameters with Min and Max values are guaranteed with production tests or SQC (Statistical Quality Control) methods.

5.1 Electrical Characteristics

Figure 7:
Electrical Parameters

Parameter	Conditions	Min	Typ	Max	Unit
Optical Output Power ⁽¹⁾	Pulse width=100 μ s, Duty cycle = 2%, @ 5 A @ 25 °C	3.62		4.82	W
Operating Voltage ⁽¹⁾	Pulse width=100 μ s, Duty cycle = 2%, @ 5 A @ 25 °C	1.8		2.7	V
Slope Efficiency	Pulse width=100 μ s, Duty cycle = 2%, @ 5 A @ 25 °C	0.7		1.05	W/A
Threshold Current	Pulse width=100 μ s, Duty cycle = 2%, @ 25 °C	0.3		1.2	A
Power Conversion Efficiency	Pulse width=100 μ s, Duty cycle = 2%, @ 5 A @ 25 °C	31		45	%

(1) Depending on driving conditions and thermal management.

5.2 Optical Characteristics

Figure 8:
Optical Parameters

Parameter	Condition	Min	Typ	Max	Unit
Global Uniformity ⁽¹⁾	Pulse width=100 μ s, Duty cycle = 2%, @ 4 A @ 25 °C	-25		+25	%
Wavelength	Pulse width=100 μ s, Duty cycle = 2%, @ 4 A @ 25 °C	842	850	858	nm
Spectral Width ⁽²⁾	Pulse width=100 μ s, Duty cycle = 2%, @ 4 A @ 25 °C	0.1		3	nm

- (1) Maximum deviation between average intensity in scanning windows rolling in 1° steps within the 80% intensity level.
- (2) Full width at half maximum.

Figure 9:
Field of Illumination (FOI)

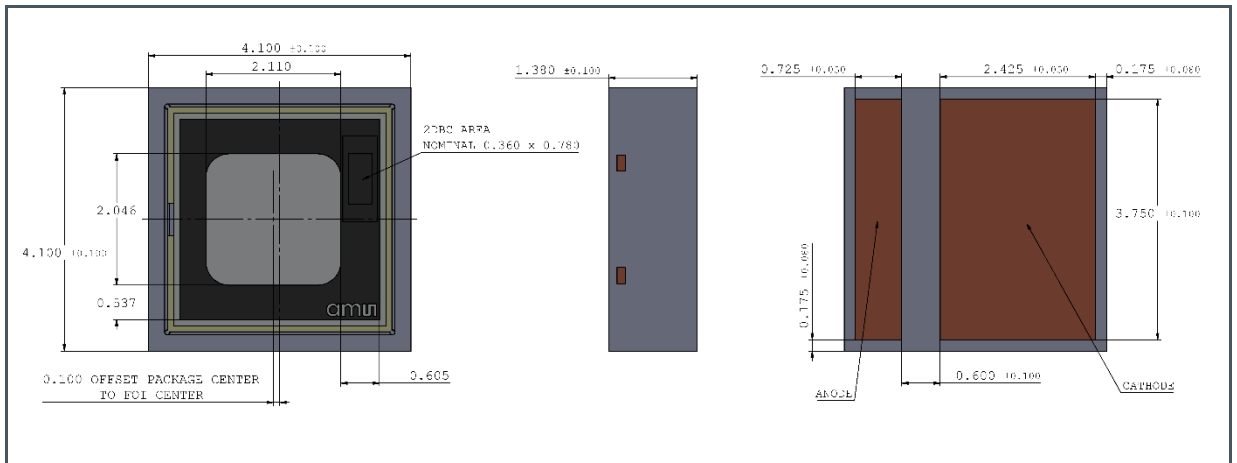
Parameter	Condition	Min	Typ	Max	Unit
Horizontal FOI ⁽¹⁾⁽²⁾	Pulse width = 100 μ s, Duty cycle = 2%, @ 4 A @ 25 °C	125.5	129.5	133.5	deg
Vertical FOI ⁽¹⁾⁽²⁾	Pulse width = 100 μ s, Duty cycle = 2%, @ 4 A @ 25 °C	110.5	114.5	118.5	deg

- (1) Angle at 50% level normalized to the centroid.
- (2) Based on radiant intensity (W/sr).

6 Package Drawings

The drawing below is showing the module size and tolerances of the TARA2000-850-UW-AUT module.

Figure 10:
Package Dimensions⁽¹⁾



(1) All dimensions in mm

Figure 11:
Top and Bottom View

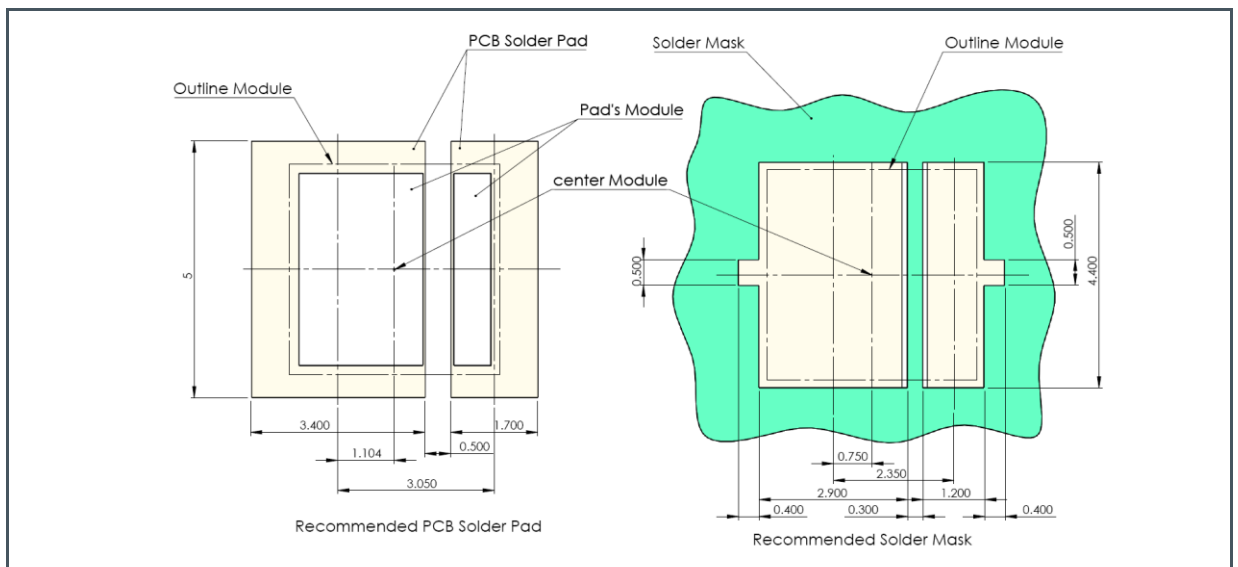


7 Application Information

7.1 PCB Pad Layout and Solder Mask Recommendation

The drawing below is showing a recommendation for pad layouts and solder mask. This is only to be used as guide and not to be considered as a firm specification.

Figure 12:
Recommended PCB Pad Layout (top view)⁽¹⁾

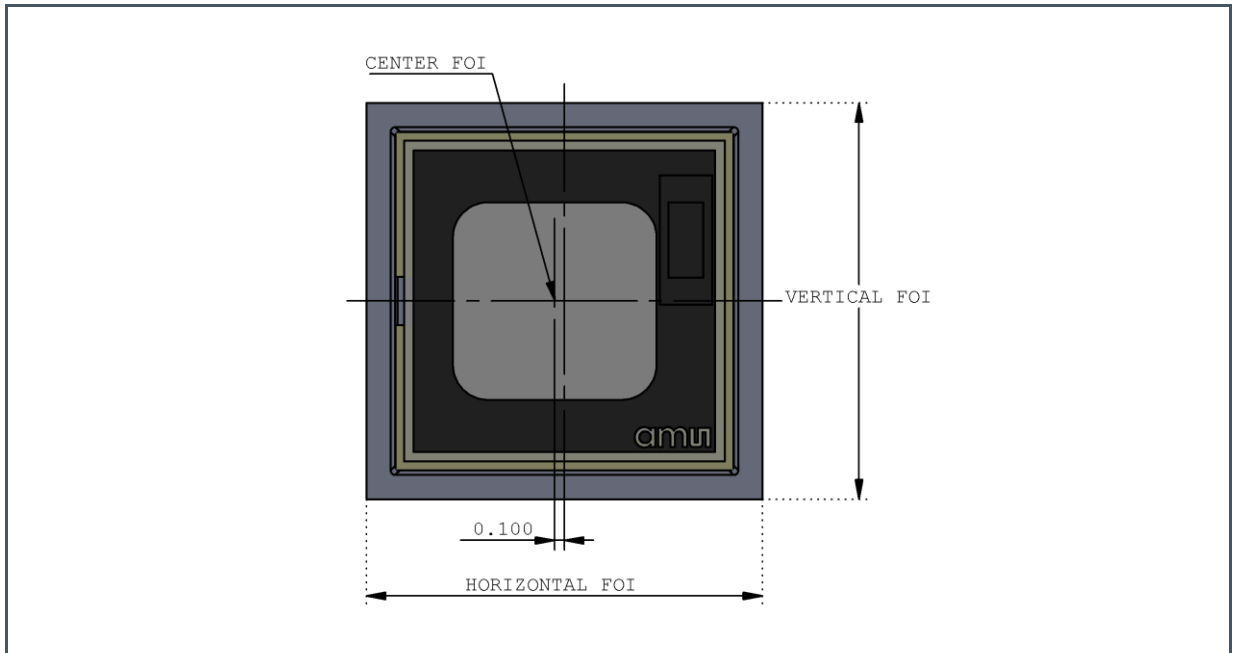


(1) All dimensions in mm.

7.2 Orientation of the Field of Illumination

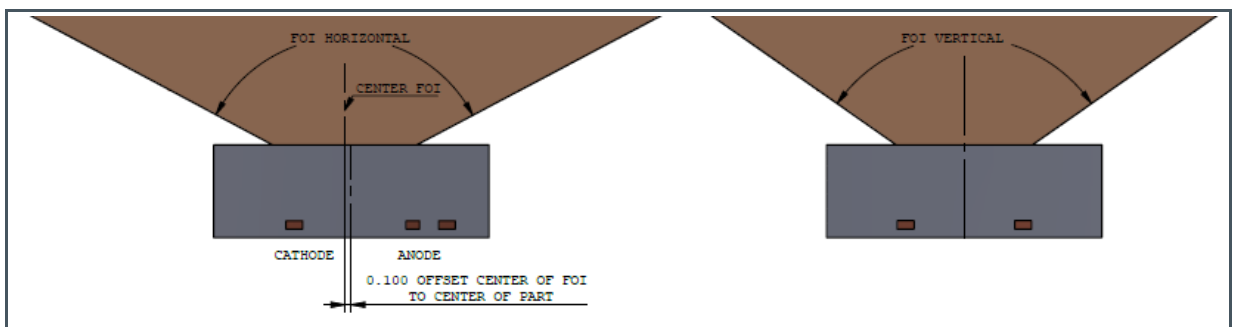
The drawings below are showing the emitting area of the TARA2000-850-UW-AUT module.

Figure 13:
FOI Orientation Regarding Module Footprint



(1) All dimensions in mm.

Figure 14:
FOI Projection



(1) All dimensions in mm.

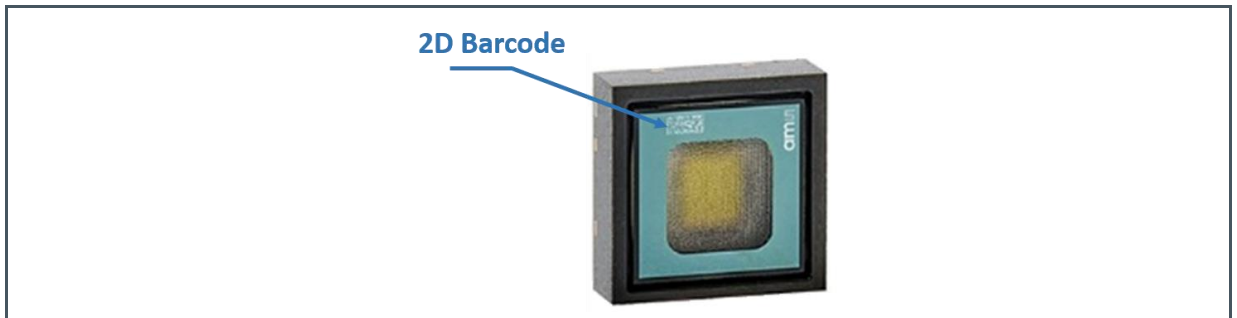
7.3 Information on the 2D Barcode

The figure below shows the 2D barcode on the module that can be used for traceability purpose. The 2D barcode has 14 characters and contains the following information:

- Optics Lot number
- Year / Month / Day of manufacturing
- Lot running number and row & column coordinates located in the wafer
- Build type
- Configuration details

The module lot number can be traced back through module traceability report by referencing to the optics lot number.

Figure 15:
2D Barcode Location on the Module



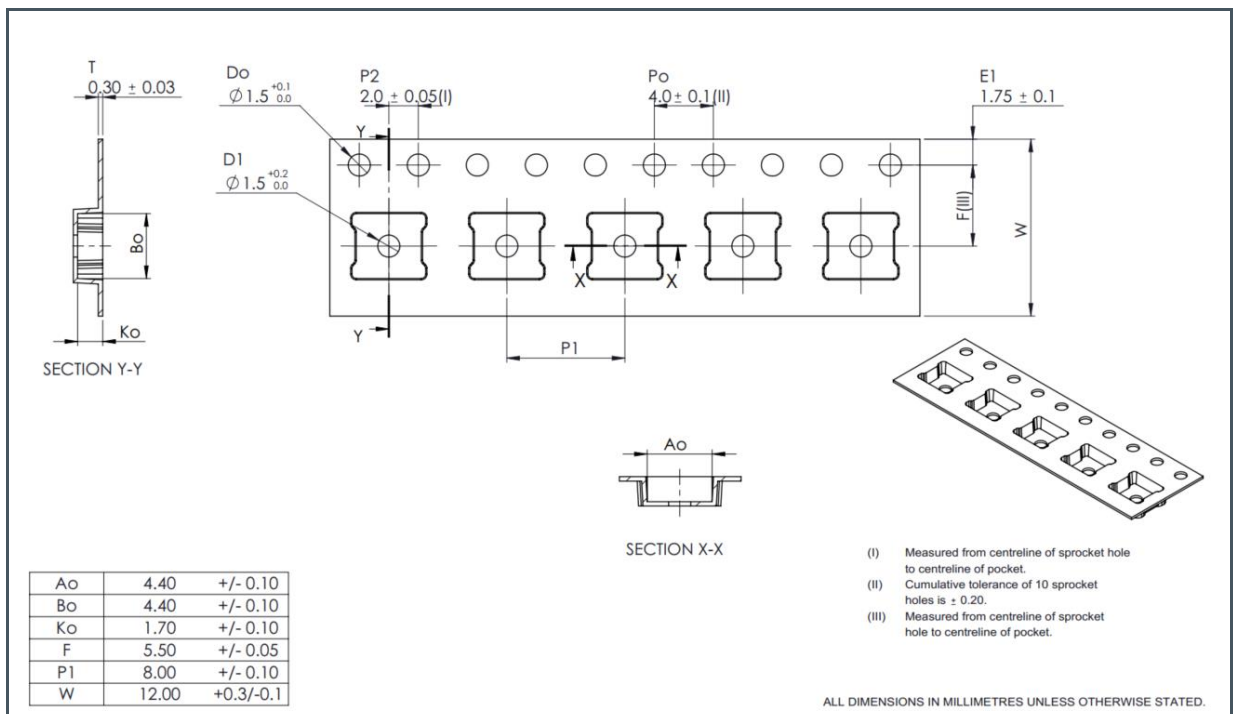
8 Tape & Reel Information

8.1 Overview

Sampling Shipments: The modules are shipped in tape & reel

MP Shipments: The modules are shipped in tape & reel

Figure 16:
Carrier Tape Dimensions and Overview (1)(2)(3)



- (1) Cover tape dimensions are 9.3 mm.
- (2) Device pin 1 oriented towards tape holes.
- (3) Reference material: Polystyrene carrier and Polyester clear tape

8.2 Plastic Reel & MBB Bag

Reels are individually labeled and put inside a Moisture Barrier Bag (MBB). The label information is as follows:

- Part number
- Lot number
- Date code manufacturing
- Manufacturing country
- Expire date
- VCSEL batch
- Quantity
- Supplier information

Figure 17:
Shipping Label Example

	SN	Field	Definition	Remarks
	1	Part No	Part Number	Product Device/Config
	2	PT Lot No	Lot Number	Lot Number from system
	3	Date Code 1	Date Code manufacturing	20 = year 2020, 08= week 08
	4	Date Code 2	Date Code Lot 2 (merge lot)	
	5	COO	Manufacturing Country	TH= Thailand
	6	Expire date	Expire date about 1 year from manufacturing date	1 year from date code
	7	Wafer No	VCSEL batch	
	8	Wafer No 2	VCSEL batch 2 (merge lot)	
	9	Quantity	Quantity of unit	
10	Supplier info	2D code information		

Label Size : 80x48 mm

8.3 MSL Label

The Moisture Sensitivity Level information is mentioned in the MBB Bag as shown in the figure below.

Figure 18:
MSL Label Example on MBB Bag

CAUTION
This bag contains
MOISTURE-SENSITIVE DEVICES

LEVEL 3
If Blank, see adjacent bar code label

1. Calculated shelf life in sealed bag : 12 months at <math> < 40^{\circ}\text{C}</math> and <math> < 90\%</math> relative humidity (RH).

2. Peak package body temperature : 260 $^{\circ}\text{C}$
If Blank, see adjacent bar code label

3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be

a) Mounted within : 168 hours of factory
If Blank, see adjacent bar code label
conditions $\leq 30^{\circ}\text{C} / 60\%$

b). Stored at <math> < 10\%</math> RH.

4. Devices require bake, before mounting, if :

a) Humidity Indicator Card is >10% when read at $23 \pm 5^{\circ}\text{C}$
b) 3a or 3b not met.

5. If baking is required, devices may be baked for 48h, at $125 \pm 5^{\circ}\text{C}$
Note : if device containers cannot be subjected to high temperature or shorter bake time are desired, reference IPC/JEDEC J-STD-033 for bake procedure.

Bag Seal Date : 2008
If Blank, see adjacent bar code label

Note: Level and body temperature defined by IPC/JEDEC J-STD-020

MSL Level 3

Peak Package body temperature = 260°C

Control pot life after open MBB Bag = 168 hours

Bag Seal Date Code

Size : 100x100 mm

8.4 Label at Outer Box

The outer box containing all the plastic reels contain information as shown in the figure below.

Figure 19:
Label at Outer Box Example

Size : 140x80 mm

S N	Field	Definition	Remarks
1	(P) Material No (Customer Part No)	Material Number	Customer partnumber for shipping label
2	Vendor P/N	Manufacturing part number	Marketing / Ordering Code
3	Vendor	Manufacturing part number	Vendor Code (for shipping label)
4	(Q) Quantity	Package quantity	built quantity
5	(4L) Country of Assembly	Country of Origin	this is similar with Country of Origin
6	(K) Trans. ID (Customer P.O No)	Need Info	Customer PO from Picklist
7	(P) SEC	Need Info	Customer partnumber for shipping label
8	MPN	Material Number	SAP MatNr
9	(2S) Shipment ID	Need Info	Picklist Generated - Hana generated
10	(3S) Package ID	Need Info	HUMO Identification - Hana generated
11	Gross Weight	Weight	actual weight of box for shipment

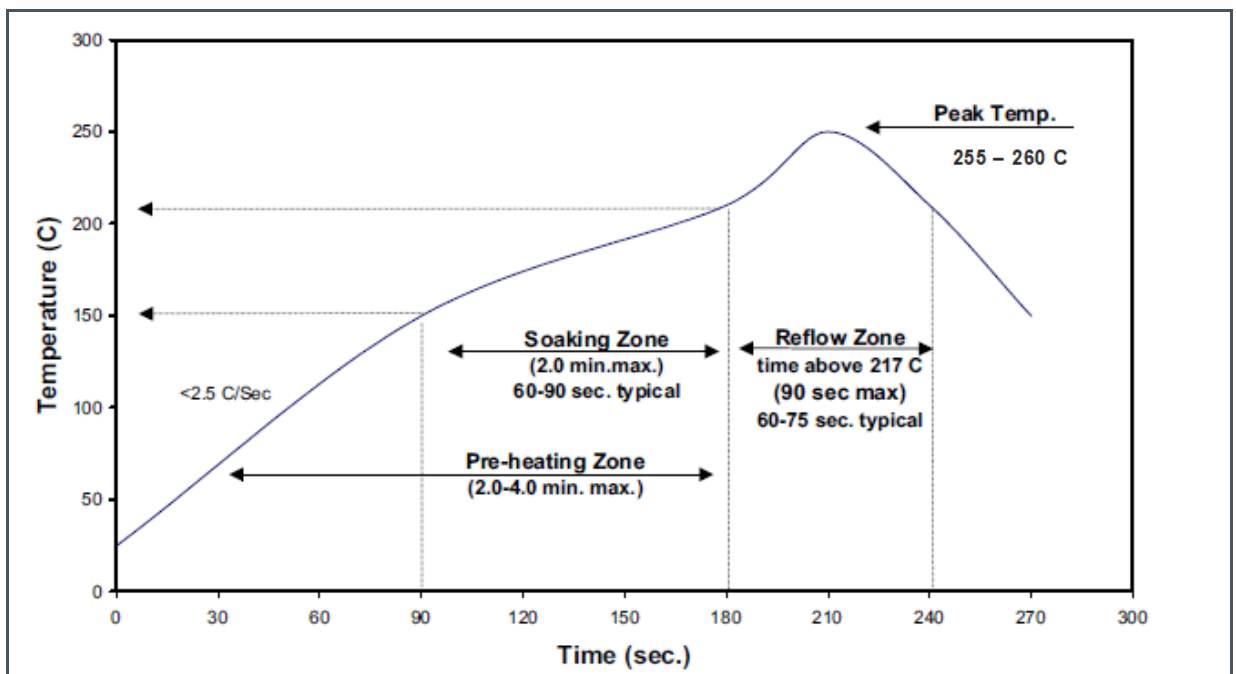
9 Soldering & Storage Information

9.1 Soldering Information

The TARA2000-850-UW-AUT modules have been tested for lead-free solder reflow compatibility with peak temperatures up to 260 °C.

Although an example reflow profile is provided in the following figure, the exact reflow profile may depend on exact solder used.

Figure 20:
Solder Reflow Profile Graph Example (for reference only)



Attention

- It is not advised to proceed to cleaning after SMT reflow process.
- The modules **MUST NOT** be cleaned using ultrasonic cleaning.
- We suggest to use “no clean solder paste” and not to clean after SMT.
- In case a cleaning is un-avoidable, rinse with DI water, followed by a 2h bake @70 °C.

9.2 Storage Information

Moisture sensitivity optical characteristics of the device can be adversely affected during the soldering process by the release and vaporization of moisture that has been previously absorbed into the package. To ensure the package contains the smallest amount of absorbed moisture possible, each device is baked prior to being dry packed for shipping. Devices are dry packed in a sealed aluminized envelope called a moisture-barrier bag with silica gel to protect them from ambient moisture during shipping, handling, and storage before use.

9.3 Shelf Life

The calculated shelf life of the device in an unopened moisture barrier bag is 12 months from the date code on the bag when stored under the following conditions:

- Shelf Life: 12 months
- Ambient Temperature: <40 °C
- Relative Humidity: <90%

Rebaking of the devices will be required if the devices exceed the 12 months shelf life and the Humidity Indicator Card shows that the devices were exposed to conditions beyond the allowable moisture region.

9.4 Floor Life

The module has been assigned a moisture sensitivity level of MSL 3. As a result, the floor life of devices removed from the moisture barrier bag is 168 hours from the time the bag was opened, provided that the devices are stored under the following conditions:

- Floor Life: 168 hours
- Ambient Temperature: <30 °C
- Relative Humidity: <60%

If the floor life or the temperature/humidity conditions have been exceeded, the devices must be rebaked prior to solder reflow or dry packing.

9.5 Rebaking Instructions

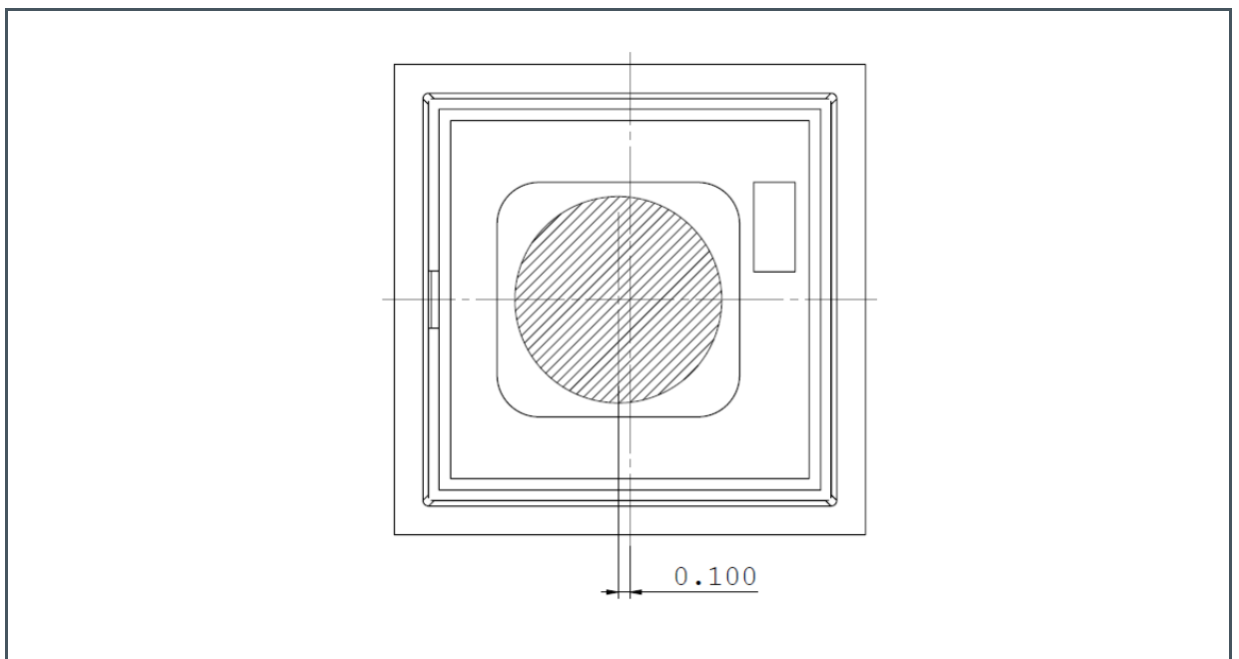
When the shelf life or floor life limits have been exceeded, rebaking is required based on recommended baking conditions (7h at 105 °C).

10 Handling

10.1 Pick Up

Recommended pick up position on the top window (hatched area in the figure), touching directly the glass.

Figure 21:
Pick Up Location ⁽¹⁾



(1) All dimensions in mm.

11 Appendix

11.1 RoHS Compliance

The TARA2000-850-UW-AUT module is RoHS compliant.

11.2 Safety Advice

Depending on the operational use of the device, the modules can emit highly concentrated non-visible infrared light, which can be hazardous to the human eyes. Products incorporating these modules may have to follow the safety precautions described by IEC 60825-1 and IEC 62471.

This product emits infrared radiation and has not yet been classified under IEC 60825-1. All appropriate safety precautions should be exercised in the operation and use of this product.



CAUTION

- Avoid direct eye exposure except as may be determined and directed by purchaser.
- Appropriate protective eyewear should be worn when operating.
- Use of magnifying optical instruments with this component may increase eye hazard.
- Avoid obstructing fully the optical path, due to risk for the lens to melt and cause eye hazard.
- Obstructing, redirecting or focusing the optical power back to the module is considered a device misuse and can potentially lead to a health hazard.



LASER PRODUCT
LASER RADIATION – AVOID DIRECT EYE EXPOSURE
WAVELENGTH: 850nm
MAXIMUM OUTPUT POWER: Depends on drive mode
WEAR PROTECTIVE GLASSES

11.3 Symbols and Abbreviations

Figure 21:
Symbols and Abbreviations Used in the Datasheet

Symbol/Abbreviation	Description
DI	Deionized
FOI	Field of Illumination
FWHM	Full Width at Half Maximum
ID	Identification
IR	Infrared
LD	Laser Diode
LI	Light-Current
LIV	Light-Current-Voltage
MP	Mass Production
MSL	Moisture Sensitivity Level
RoHS	Restriction of Hazardous Substances
SMT	Surface Mount Technology
VCSEL	Vertical Cavity Surface Emitting Laser

12 Revision Information

Document Status	Product Status	Definition
Product Preview	Pre-Development	Information in this datasheet is based on product ideas in the planning phase of development. All specifications are design goals without any warranty and are subject to change without notice
Preliminary Datasheet	Pre-Production	Information in this datasheet is based on products in the design, validation or qualification phase of development. The performance and parameters shown in this document are preliminary without any warranty and are subject to change without notice
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Changes from previous version to current revision v4-00	Page
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Document security class changed from “Confidential” to “Public”

- Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.
- Correction of typographical errors is not explicitly mentioned.

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